IFW 36168

SIP-166-A

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant:

Taguchi et al.

Serial Number:

10/591,154

International App.:

PCT/JP2005/003582

International Filing:

03 March 2005

371 Filing:

30 August 2006

Confirmation No.:

6184

Group Art Unit:

3616

Examiner:

Coker, Robert A.

On-Vehicle Component Fixation-Release Apparatus

INFORMATION DISCLOSURE STATEMENT UNDER MPEP §609

Commissioner For Patents PO Box 1450 Alexandria, VA 22313-1450

Sir:

Pursuant to 37 CFR §1.56, §1.97, §1.98, and MPEP §609, applicant encloses form PTO/SB/08A for consideration by the Examiner. Further to OG Date: 05 August 2003, the U.S. patent reference is not enclosed. The references are discussed/cited in the enclosed Office Action dated 03 March 2009. The references not enclosed, JP 08-268059, JP 02-034452, JP 2001-191878 and WO 99/39156 were previously cited as part of this application.

Each item of information contained in the information disclosure statement was first cited in any communication from a foreign patent office in a counterpart foreign application not more that three months prior to the filing of the information disclosure statement. 37 CFR 1.97(e)(1).

The listed references are being cited only in the interests of candor and without any admission that they constitute statutory prior art or contains matter which anticipates the present invention or which would render the same obvious, either singly or in combination, to a person of ordinary skill in the art.

Favorable consideration is respectfully requested.

Respectfully submitted,

Customer Number 21828 Carrier, Blackman & Associates, P.C. 24101 Novi Road, Suite 100 Novi, Michigan 48375 27 May 2009

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I hereby certify that this correspondence is being deposited with the U.S. Postal Service with sufficient postage as first class mail in an envelope addressed to Commissioner For Patents, PO Box 1450, Alexandria, VA 22313-1450 on 27 May 2009.

Dated: 27 May 2009

JPC/pmp enclosures

Paula M. Patterson